## TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-IC

# **TLP108**

Isolated bus drivers
High speed line receivers
Microprocessor system interfaces

The Toshiba TLP108 consists of a GaAlAs light emitting diode optically coupled to a high-gain, high-speed photodetector.

The TLP108 is housed in a 6-pin MFSOP.

With a totem-pole output, the TLP108 is capable of both sinking and sourcing current.

The TLP108 has an internal Faraday shield, which provides a guaranteed common-mode transient immunity of  $\pm 10 \text{ kV/}\mu\text{s}$ .

The TLP108 has an inverting output. A noninverting-output version, the TLP105, is also available.

- Inverter logic type (totem-pole output)
- Guaranteed Performance Over temperature: -40 to 100°C
- Power Supply Voltage: 4.5 to 20 V
- Input Threshold Current: IFHL =1.6 mA (max)
- Switching Time (t<sub>pLH</sub>/t<sub>pHL</sub>): 250 ns (max)
- Common mode transient immunity: ±10 kV/μs
- Isolation Voltage: 3750 Vrms

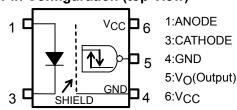
### **Truth Table**

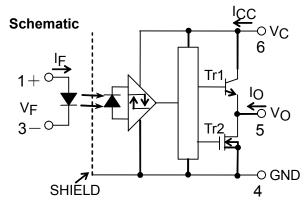
Input	LED	Tr1	Tr2	Output
Н	ON	OFF	ON	L
L	OFF	ON	OFF	Н

# Unit in mm 6 5 4 7.0±0.4 11-4C2 JEDEC — TOSHIBA 11-4C2

Weight: 0.09 g (typ.)

# Pin Configuration (top View)





0.1  $\mu F$  bypass capacitor must be connected between pin 6 and 4.

# **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Input Current , ON	I <sub>F(ON)</sub>	2	_	10	mA
Input Voltage , OFF	V <sub>F</sub> (OFF)	0	_	0.8	V
Supply Voltage*	VCC	4.5	_	20	V
Operating Temperature	T <sub>opr</sub>	-40	_	100	°C
Fan-out (TTL Load)	N	1	_	4	

<sup>\*</sup> This item denotes operating range, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

# Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	ΙF	20	mA
ED	Peak Transient Forward Current (Note1)	IFPT	1	Α
	Reverse Voltage	$V_{R}$	5	V
	Output Current 1 (Ta ≤ 25°C)	l <sub>O1</sub>	25/-15	mA
DETECTOR	Output Current 2 (Ta ≤ 100°C)	I <sub>O2</sub>	5/-5	mA
EC.	Peak Output Current (Note2)	lop	50/-50	mA
DET	Output Voltage	VO	-0.5 to 20	V
	Supply Voltage	VCC	-0.5 to 20	V
Oper	ating Temperature Range	T <sub>opr</sub>	-40 to 100	°C
Stora	ge Temperature Range	T <sub>stg</sub>	-55 to 125	°C
Lead	Solder Temperature (10s)	T <sub>sol</sub>	260	°C
	tion Voltage (AC,1min.,R.H. ≤ 60%,Ta=25°C) (Note3)	BV <sub>S</sub>	3750	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width  $\leq 1 \mu s$ , 300pps.

Note 2: Pulse width  $\leq 5 \mu s, \ duty \ cycle \leq 0.025$ 

Note 3: Device considered a two terminal device: pins 1 and 3 shorted together and pins 4, 5 and 6 shorted together.

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# Electrical Characteristics (Unless otherwise specified, Ta = -40 to 100°C, V<sub>CC</sub> = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CON	IDITION	MIN	TYP.	MAX	UNIT
Input Forward Voltage	VF	_	I <sub>F</sub> =10 mA , Ta=	:25°C	1.45	1.57	1.75	V
Temperature Coefficient of Forward Voltage	ΔV <sub>F</sub> /ΔTa	I	I <sub>F</sub> =10 mA		_	-2.0		mV/°C
Input Reverse Current	I <sub>R</sub>	-	V <sub>R</sub> =5 V , Ta=2	5°C	_	_	10	μА
Input Capacitance	CT	_	V=0 , f=1 MHz	, Ta=25°C	_	100	_	pF
Logic Low Output Voltage	V <sub>OL</sub>	1	I <sub>OL</sub> =3.5 mA , I	==5 mA	_	0.2	0.6	V
Lania Histo Outsut Valtana	.,		I <sub>OH</sub> =-2.6 mA,	V <sub>CC</sub> =4.5 V	2.7	4.0	_	
Logic High Output Voltage	VOH	2	V <sub>F</sub> =0.8 V	V <sub>CC</sub> =20 V	17.4	19.0	_	V
Logic Low Supply Current	ICCL	3	I <sub>F</sub> =5 mA	V <sub>CC</sub> =20 V	_	_	3.0	mA.
				V <sub>CC</sub> =5.5 V	_	_	3.0	ША
	loou	4	V <sub>F</sub> =0 V	V <sub>CC</sub> =20 V	_	_	3.0	m A
Logic High Supply Current	ICCH	4	VF-0 V	V <sub>CC</sub> =5.5 V	_	_	3.0	mA
Logic Low Short Circuit	la a	-	I <sub>F</sub> =5 mA	V <sub>CC</sub> =VO=5.5 V	15	80	_	- m A
Output Current (Note4)	losl	5	V <sub>O</sub> =GND	V <sub>CC</sub> =VO=20 V	20	90	_	mA
Logic High Short Circuit	1	0	\/0\/	V <sub>CC</sub> =5.5 V	-5	-15	_	^
Output Current (Note4)	losh	6	V <sub>F</sub> =0 V	V <sub>CC</sub> =20 V	-10	-20	_	mA
Input Current Logic Low Output	IFHL	_	I <sub>O</sub> =3.5 mA,V <sub>O</sub> <0.4 V		_	0.4	1.6	mA
Input Voltage Logic High Output	V <sub>FLH</sub>	_	I <sub>O</sub> =-2.6 mA,V <sub>O</sub> >2.4 V		0.8	_	_	V
Input Current Hysteresis	l <sub>HYS</sub>	_	V <sub>CC</sub> =5 V		_	0.05	_	mA

<sup>\*</sup>All typical values are at Ta=25°C

Note 4: Duration of output short circuit time should not exceed 10 ms.

# **Isolation Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance input to output	CS	$V_S = 0, f = 1 \text{ MHz}$ (Note 3)	_	8.0	_	pF
Isolation resistance	RS	R.H. ≤ 60%,V <sub>S</sub> = 500 V (Note 3)	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
		AC,1 minute	3750	_	_	V
Isolation voltage	BVS	AC,1 second,in oil	_	10000	_	V <sub>rms</sub>
		DC,1 minute,in oil	_	10000	_	V <sub>dc</sub>

Note 5: A ceramic capacitor  $(0.1\mu\text{A})$  should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

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# **Switching Characteristics** (Unless otherwise specified, Ta = -40 to 100°C, V<sub>CC</sub> = 4.5 to 20 V)

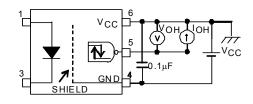
CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation Delay Time to Logic High output	<sup>t</sup> pLH		I <sub>F</sub> =3→0mA	30	150	250	ns
Propagation Delay Time to Logic Low output	<sup>t</sup> pHL	7.0	I <sub>F</sub> =0→3mA	30	150	250	ns
Switching Time Dispersion between ON and OFF	t <sub>pHL</sub> - t <sub>pLH</sub>	7, 8	_	1	1	220	ns
Rise Time (10 – 90 %)	t <sub>r</sub>		I <sub>F</sub> =3→0mA , V <sub>CC</sub> =5V		30	75	ns
Fall Time (90 – 10 %)	t <sub>f</sub>		I <sub>F</sub> =0→3mA , V <sub>CC</sub> =5V		30	75	ns
Common Mode transient Immunity at High Level Output	СМН	0	$V_{CM}$ =1000 $V_{p-p}$ , $I_F$ =0mA, $V_{CC}$ =20 $V$ , $Ta$ =25° $C$	-10000			V/μs
Common Mode transient Immunity at Low Level Output	CML	9	$V_{CM}$ =1000 $V_{p-p}$ , $I_F$ =5mA, $V_{CC}$ =20 $V$ , Ta=25°C	10000	_	_	V/μs

<sup>\*</sup>All typical values are at Ta=25°C

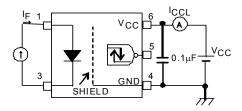


lor-Test Circuit 3: ICCL

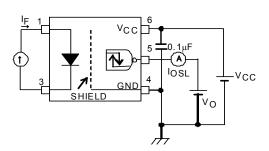
Test Circuit 2: VOH



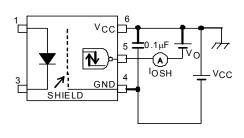
Test Circuit 4: ICCH



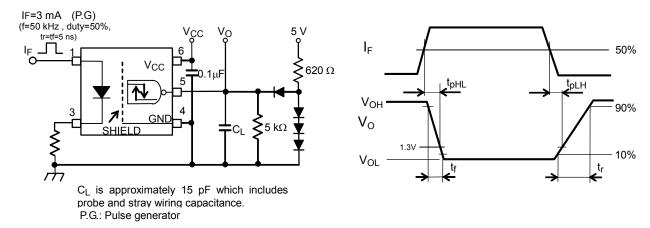
Test Circuit 5: IOSL



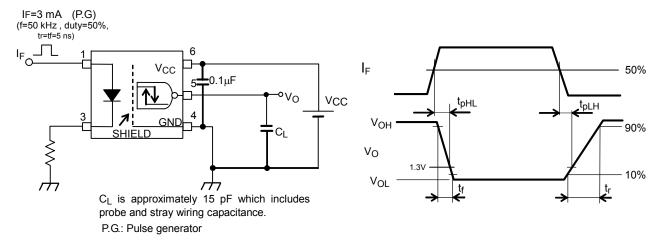
Test Circuit 6: IOSH



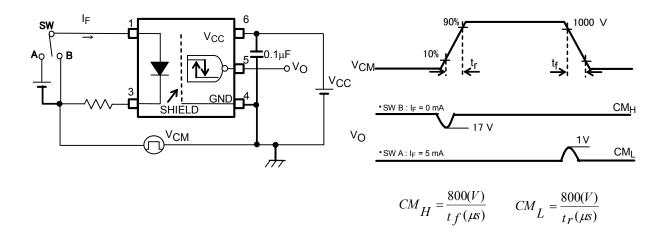
# **Test Circuit 7: Switching Time Test Circuit**



# **Test Circuit 8: Switching Time Test Circuit**



# **Test Circuit 9: Common Mode Transient Immunity Test Circuit**



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